

TRANSMITTAL FOR U.S. PATENT APPLICATION  
UNDER 37 CFR §1.53(b)

**Box Patent Application**  
ASSISTANT COMMISSIONER  
OF PATENTS  
Washington, D.C. 20231

Attorney's Docket: 021208.0238

Sir:

Transmitted herewith for filing is the original patent application of:

Inventor: Ajit P. Paranjpe, et al.

For: **ATOMIC LAYER DEPOSITION FOR FABRICATING THIN  
FILMS**


Enclosed are:

- (1) 34 pages of Specification, Claims and Abstract;
- (2)      pages of Executed Declaration and Power of Attorney;
- (3)   7   pages of Formal Drawings;
- (4)      page executed Verified Statement Claiming Small Entity Status under 37 C.F.R. §§ 1.9(f) and 1.27(c) Small Business Concern;
- (5)      pages of an Assignment of the invention to Netpliance, Inc.;
- (6)      pages of a separate cover sheet in compliance with 37 C.F.R. § 3.28 and § 3.31 is included with an Assignment recordal fee of \$40.00 pursuant to 37 C.F.R. § 1.21(h);
- (7)      pages Information Disclosure Statement with PTO-1449 Form (     pages) & attached references Acco bound (     references);
- (8)   1   page Certificate of Mailing by Express Mail; and
- (9)   2   pages Patent Application Bibliographic Data sheet (PrintEFS Version 1.0.1); and
- (10) This Transmittal Form with attached patent application filing fee in the amount of \$926.00.

FEE CALCULATION					FEE
	Number		Number Extra	Rate	Basic Fee
Total Claims	32	20	12	X \$18 =	216.00
Independent Claims	3	3	0	X \$80 =	0.00
TOTAL FILING FEE =					\$926.00

Please charge any additional fees or credit any overpayment to Deposit Account No. 02-0384 of Baker Botts L.L.P. A duplicate copy of this sheet is enclosed.

BAKER BOTTS L.L.P.  
Attorneys for Applicants

  
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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:     Ajit P. Paranjpe, et al.  
Date Filed:             May 23, 2001  
Title:                    ATOMIC LAYER DEPOSITION FOR  
                            FABRICATING THIN FILMS

Box Patent Application  
Honorable Assistant Commissioner  
of Patents  
Washington, D.C. 20231

Dear Sir:

CERTIFICATE OF MAILING BY EXPRESS MAIL

I hereby certify that the attached Application Data Sheet, Transmittal, Patent Application, and Formal Drawings are being deposited with the United States Postal Service "Express Mail Post Office to Addressee" service under 37 C.F.R. 1.10 on this 23rd day of May, 2001, and is addressed to the Assistant Commissioner of Patents, Washington, D.C. 20231.

  
Heather Bergeron

Express Mail Receipt  
No. EL740056656US  
Attorney's Docket:  
021208.0238